

2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER PowerDI[™]123

Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- Low Forward Voltage Drop
- Lead Free Finish, RoHS Compliant (Note 5)
- "Green" Molding Compound (No Br, Sb)

Mechanical Data

- Case: PowerDI[™]123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Marking & Type Code Information: See Last Page
- Ordering Information: See Last Page
- Weight: 0.01 grams (approximate)



13

<L41

Dim	Min	Max	Тур				
Α	3.50	3.90	3.70				
В	2.60	3.00	2.80				
С	1.63	1.93	1.78				
D	0.93	1.00	0.98				
Е	0.85	1.25	1.00				
н	0.15	0.25	0.20				
L	0.45	0.85	0.65				
L1		_	1.35				
L2		_	1.10				
L3	_	_	0.20				
L4	0.90	1.30	1.05				
All Dimensions in mm							

PowerDI[™]123

Maximum Ratings @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		30	V
RMS Reverse Voltage	V _{R(RMS)}	21	V
Average Forward Current @ T _T = 120°C	I _{F(AV)}	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	40	А
Power Dissipation (Note 1)	PD	1.67	W
Power Dissipation (Note 2)		556	mW
Thermal Resistance Junction to Ambient (Note 1)	R _{0JA}	60	°C/W
Thermal Resistance Junction to Ambient (Note 2)	R _{0JA}	180	°C/W
Thermal Resistance Junction to Soldering (Note 3)	R _{0JS}	10	°C/W
Operating Temperature Range		-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic		Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 4)	V _{(BR)R}	30			V	I _R = 1.5mA
Forward Voltage	VF		0.36 0.4	0.42 0.49	V	I _F = 1.0A I _F = 2.0A
Leakage Current (Note 4)	I _R	—	0.15	1.0	mA	V _R = 30V, T _A = 25°C
Total Capacitance	CT		75	_	pF	V _R = 10V, f = 1.0MHz

Notes: 1. Part mounted on 50.8mm X 50.8mm GETEK board with 25.4mm X 25.4mm copper pad, 25% anode, 75% cathode. T_A = 25°C

2. Part mounted on FR-4 board with 1.8mm X 2.5mm cathode and 1.8mm X 1.2mm anode, 1 oz. copper pads. TA = 25°C

3. Theoretical $R_{\theta JS}$ calculated from the top center of the die straight down to the PCB cathode tab solder junction.

4. Short duration pulse test to minimize self-heating effect.

5. RoHS revision 13.2.2003. High Temperature Solder Exemption Applied, see EU Directive Annex Note 7.

DS30518 Rev. 2 - 1

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DFLS230







Ordering Information (Note 6)

Device	Packaging	Shipping
DFLS230-7	PowerDI [™] 123	3000/Tape & Reel

Notes: 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



F01A = Product Type Marking Code YM = Date Code Marking Y = Year (ex: R = 2004) M = Month (ex: 9 = September)

Date Code Key

Year 200		004	2005	2006	2007	2008	200	09 2	2010	2011	2012	
Code			R	S	Т	U	V	V	/	Х	Y	Z
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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